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**Industrial communication networks – Profiles –
Part 3-3: Functional safety fieldbuses – Additional specifications for CPF 3**

**Réseaux de communications industriels – Profils –
Partie 3-3: Bus de terrain de sécurité fonctionnelle – Spécifications
supplémentaires pour CPF 3**

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IEC Central Office
3, rue de Varembe
CH-1211 Geneva 20
Switzerland

Tel.: +41 22 919 02 11
Fax: +41 22 919 03 00
info@iec.ch
www.iec.ch

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CONTENTS

FOREWORD.....	8
INTRODUCTION.....	10
1 Scope.....	13
2 Normative references	13
3 Terms, definitions, symbols, abbreviated terms and conventions	15
3.1 Terms and definitions	15
3.1.1 Common terms and definitions	15
3.1.2 CPF 3: Additional terms and definitions	19
3.2 Symbols and abbreviated terms.....	23
3.2.1 Common symbols and abbreviated terms	23
3.2.2 CPF 3: Additional symbols and abbreviated terms	23
3.3 Conventions	24
4 Overview of FSCP 3/1 (PROFIsafe™)	25
5 General	27
5.1 External documents providing specifications for the profile.....	27
5.2 Safety functional requirements	27
5.3 Safety measures	28
5.4 Safety communication layer structure.....	29
5.4.1 Principle of FSCP 3/1 safety communications.....	29
5.4.2 CPF 3 communication structures.....	30
5.5 Relationships with FAL (and DLL, PhL)	33
5.5.1 Device model.....	33
5.5.2 Application and communication relationships.....	33
5.5.3 Message format.....	35
5.5.4 Data types.....	35
6 Safety communication layer services.....	36
6.1 F-Host services.....	36
6.2 F-Device services.....	39
6.3 Diagnosis.....	40
6.3.1 Safety alarm generation.....	40
6.3.2 F-Device safety layer diagnosis including the iPar-Server.....	40
7 Safety communication layer protocol	41
7.1 Safety PDU format	41
7.1.1 Safety PDU structure	41
7.1.2 Safety I/O data	42
7.1.3 Status and Control Byte.....	42
7.1.4 (Virtual) Consecutive Number.....	44
7.1.5 CRC2 Signature	45
7.1.6 Appended standard I/O data.....	46
7.2 FSCP 3/1 behavior	46
7.2.1 General	46
7.2.2 F-Host state diagram	47
7.2.3 F-Device state diagram.....	50
7.2.4 Sequence diagrams.....	54
7.2.5 Timing diagram for a counter reset	60

7.2.6	Monitoring of safety times.....	60
7.3	Reaction in the event of a malfunction.....	63
7.3.1	Repetition.....	63
7.3.2	Loss.....	63
7.3.3	Insertion.....	63
7.3.4	Incorrect sequence.....	63
7.3.5	Corruption of safety data.....	63
7.3.6	Delay.....	64
7.3.7	Masquerade.....	64
7.3.8	Memory failures within switches.....	65
7.3.9	Network boundaries and router.....	66
7.4	F-Startup and change coordination.....	66
7.4.1	Standard startup procedure.....	66
7.4.2	iParameter assignment deblocking.....	66
8	Safety communication layer management.....	67
8.1	F-Parameter.....	67
8.1.1	Summary.....	67
8.1.2	F_Source/Destination_Address (codename).....	67
8.1.3	F_WD_Time (F-Watchdog time).....	68
8.1.4	F_Prm_Flag1 (Parameters for the safety layer management).....	68
8.1.5	F_Prm_Flag2 (Parameters for the safety layer management).....	69
8.1.6	F_iPar_CRC (value of iPar_CRC across iParameters).....	70
8.1.7	F_Par_CRC (CRC1 across F-Parameters).....	71
8.1.8	Structure of the F-Parameter record data object.....	71
8.1.9	F-Data fraction.....	71
8.2	iParameter and iPar_CRC.....	72
8.3	Safety parameterization.....	73
8.3.1	Objectives.....	73
8.3.2	GSD and GSDML safety extensions.....	73
8.3.3	Securing safety parameters and GSD data.....	74
8.4	Safety configuration.....	76
8.4.1	Securing the safety I/O data description (CRC7).....	76
8.4.2	Dataltem data type section examples.....	77
8.5	Data type information usage.....	79
8.5.1	F-Channel driver.....	79
8.5.2	Rules for standard F-Channel drivers.....	80
8.5.3	Recommendations for F-Channel drivers.....	80
8.6	Safety parameter assignment mechanisms.....	81
8.6.1	F-Parameter assignment.....	81
8.6.2	General iParameter assignment.....	82
8.6.3	System integration requirements for iParameterization tools.....	83
8.6.4	iPar-Server.....	84
9	System requirements.....	92
9.1	Indicators and switches.....	92
9.2	Installation guidelines.....	93
9.3	Safety function response time.....	93
9.3.1	Model.....	93
9.3.2	Calculation and optimization.....	95
9.3.3	Adjustment of watchdog times for FSCP 3/1.....	96

9.3.4	Engineering tool support.....	97
9.3.5	Retries (repetition of messages).....	97
9.4	Duration of demands.....	98
9.5	Constraints for the calculation of system characteristics.....	99
9.5.1	Probabilistic considerations.....	99
9.5.2	Safety related constraints.....	101
9.5.3	Non safety related constraints (availability).....	102
9.6	Maintenance.....	102
9.6.1	F-Module commissioning / replacement.....	102
9.6.2	Identification and maintenance functions.....	102
9.7	Safety manual.....	103
9.8	Wireless transmission channels.....	103
9.8.1	Black Channel approach.....	103
9.8.2	Availability.....	104
9.8.3	Security measures.....	104
9.8.4	Stationary and mobile applications.....	106
9.9	Conformance classes.....	106
10	Certification.....	107
10.1	Safety policy.....	107
10.2	Obligations.....	108
Annex A (informative) Additional information for functional safety communication profiles of CPF 3.....		109
A.1	Hash function calculation.....	109
A.2	Response time measurements.....	111
Bibliography.....		115
<p style="text-align: center;">IEC 61784-3-3:2007</p> <p>https://standards.iteh.ai/ https://standards.iteh.ai/standards/iec-61784-3-3-2007</p>		
Table 1	– Deployed measures to master errors.....	28
Table 2	– Data types used for FSCP 3/1.....	35
Table 3	– Safety layer diagnosis messages.....	41
Table 4	– F-Host states and transitions.....	48
Table 5	– F-Device states and transitions.....	52
Table 6	– SIL monitor times.....	63
Table 7	– Remedies for switch failures.....	65
Table 8	– Safety network boundaries.....	66
Table 9	– I/O data structure items (Version 2).....	76
Table 10	– Sample F-Channel drivers.....	80
Table 11	– Requirements for iParameterization.....	83
Table 12	– Specifier for the iPar-Server Request.....	87
Table 13	– Structure of the Read_RES_PDU ("read record").....	88
Table 14	– Structure of the Write_REQ_PDU ("write record").....	89
Table 15	– Structure of the Pull_RES_PDU ("Pull").....	89
Table 16	– Structure of the Push_REQ_PDU ("Push").....	89
Table 17	– iPar-Server states and transitions.....	91
Table 18	– iPar-Server management measures.....	92
Table 19	– Information to be included in the safety manual.....	103

Table 20 – Security measures for WLAN (IEEE 802.11i)	105
Table 21 – Security measures for Bluetooth (IEEE 802.15.1)	106
Table 22 – F-Host conformance class requirements	107
Table A.1 – The table "Crctab24" for 24 bit CRC signature calculations	110
Table A.2 – The table "Crctab32" for 32 bit CRC signature calculations	111
Figure 1 – Relationships of IEC 61784-3 with other standards (machinery)	10
Figure 2 – Relationships of IEC 61784-3 with other standards (process)	11
Figure 3 – Basic communication preconditions for FSCP 3/1	25
Figure 4 – Structure of an FSCP 3/1 safety PDU	26
Figure 5 – Safe communication modes	27
Figure 6 – Standard CPF 3 transmission system	29
Figure 7 – Safety layer architecture	30
Figure 8 – Basic communication layers	30
Figure 9 – Multipoint switch bus structure	31
Figure 10 – Linear bus structure	31
Figure 11 – Crossing network borders with routers	32
Figure 12 – Complete safety transmission paths	32
Figure 13 – Device model	33
Figure 14 – Application relationships of a modular device	34
Figure 15 – Application and communication relationships (AR/CR)	34
Figure 16 – Message format	35
Figure 17 – FSCP 3/1 communication structure	37
Figure 18 – F user interface of F-Host driver instances	37
Figure 19 – F-Device driver interfaces	39
Figure 20 – Safety PDU for CPF 3	42
Figure 21 – Status Byte	42
Figure 22 – Control Byte	43
Figure 23 – The Toggle Bit function	44
Figure 24 – F-Device Consecutive Number	44
Figure 25 – CRC2 generation (F-Host output)	45
Figure 26 – Details of the CRC2 calculation (reverse order)	46
Figure 27 – Safety layer communication relationship	46
Figure 28 – F-Host state diagram	47
Figure 29 – F-Device state diagram	51
Figure 30 – Interaction F-Host / F-Device during start-up	54
Figure 31 – Interaction F-Host / F-Device during F-Host power off → on	55
Figure 32 – Interaction F-Host / F-Device with delayed power on	56
Figure 33 – Interaction F-Host / F-Device during power off → on	57
Figure 34 – Interaction F-Host / F-Device while host recognizes CRC error	58
Figure 35 – Interaction F-Host / F-Device while device recognizes CRC error	59
Figure 36 – Impact of the counter reset signal	60

Figure 37 – Monitoring the message transit time F-Host ↔ F-Output	61
Figure 38 – Monitoring the message transit time F-Input ↔ F-Host	61
Figure 39 – F-Parameter data and CRC	64
Figure 40 – iParameter assignment deblocking by the F-Host	67
Figure 41 – F_Prm_Flag1	68
Figure 42 – F_Check_SeqNr	68
Figure 43 – F_Check_iPar	69
Figure 44 – F_SIL	69
Figure 45 – F_CRC_Length	69
Figure 46 – F_Prm_Flag2	70
Figure 47 – F_Block_ID	70
Figure 48 – F_Par_Version	70
Figure 49 – F-Parameter	71
Figure 50 – iParameter block	72
Figure 51 – F-Parameter extension within the GSDML specification	74
Figure 52 – CRC1 including iPar_CRC	75
Figure 53 – Algorithm to build CRC0	75
Figure 54 – DataItem section for F_IN_OUT_1	77
Figure 55 – DataItem section for F_IN_OUT_2	78
Figure 56 – DataItem section for F_IN_OUT_5	78
Figure 57 – DataItem section for F_IN_OUT_6	79
Figure 58 – F-Channel driver as "glue" between F-Device and user program	79
Figure 59 – Layout example of an F-Channel driver	80
Figure 60 – F-Parameter assignment for simple F-Devices and F-Slaves	81
Figure 61 – F and iParameter assignment for complex F-Devices	82
Figure 62 – System integration of CPD-Tools	84
Figure 63 – iPar-Server mechanism (commissioning)	84
Figure 64 – iPar-Server mechanism (for example F-Device replacement)	85
Figure 65 – iPar-Server request coding ("status model")	86
Figure 66 – Coding of SR_Type	87
Figure 67 – iPar-Server request coding ("alarm model")	88
Figure 68 – iPar-Server state diagram	90
Figure 69 – Example safety function with a critical response time path	93
Figure 70 – Simplified typical response time model	94
Figure 71 – Frequency distributions of typical response times of the model	94
Figure 72 – Context of delay times and watchdog times	95
Figure 73 – Timing sections forming the FSCP 3/1 F_WD_Time	96
Figure 74 – Frequency distribution of response times with message retries	97
Figure 75 – Retries with CP 3/1	98
Figure 76 – Retries with CP 3/RTE	98
Figure 77 – Residual error probabilities for the 24-bit polynomial	99
Figure 78 – Properness of the 32-bit polynomial for 52 octets	100
Figure 79 – Properness of the 32-bit polynomial for 132 octets	100

Figure 80 – Monitoring of corrupted messages..... 101
Figure 81 – Security for WLAN networks..... 104
Figure 82 – Security for Bluetooth networks..... 105
Figure A.83 – Typical "C" procedure of a cyclic redundancy check..... 109
Figure A.84 – Comparison of the response time model and a real application 112
Figure A.85 – Frequency distribution of measured response times..... 113
Figure A.86 – F-Host with standard and safety-related application programs 114

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**INDUSTRIAL COMMUNICATION NETWORKS –
PROFILES –**

**Part 3-3: Functional safety fieldbuses –
Additional specifications for CPF 3**

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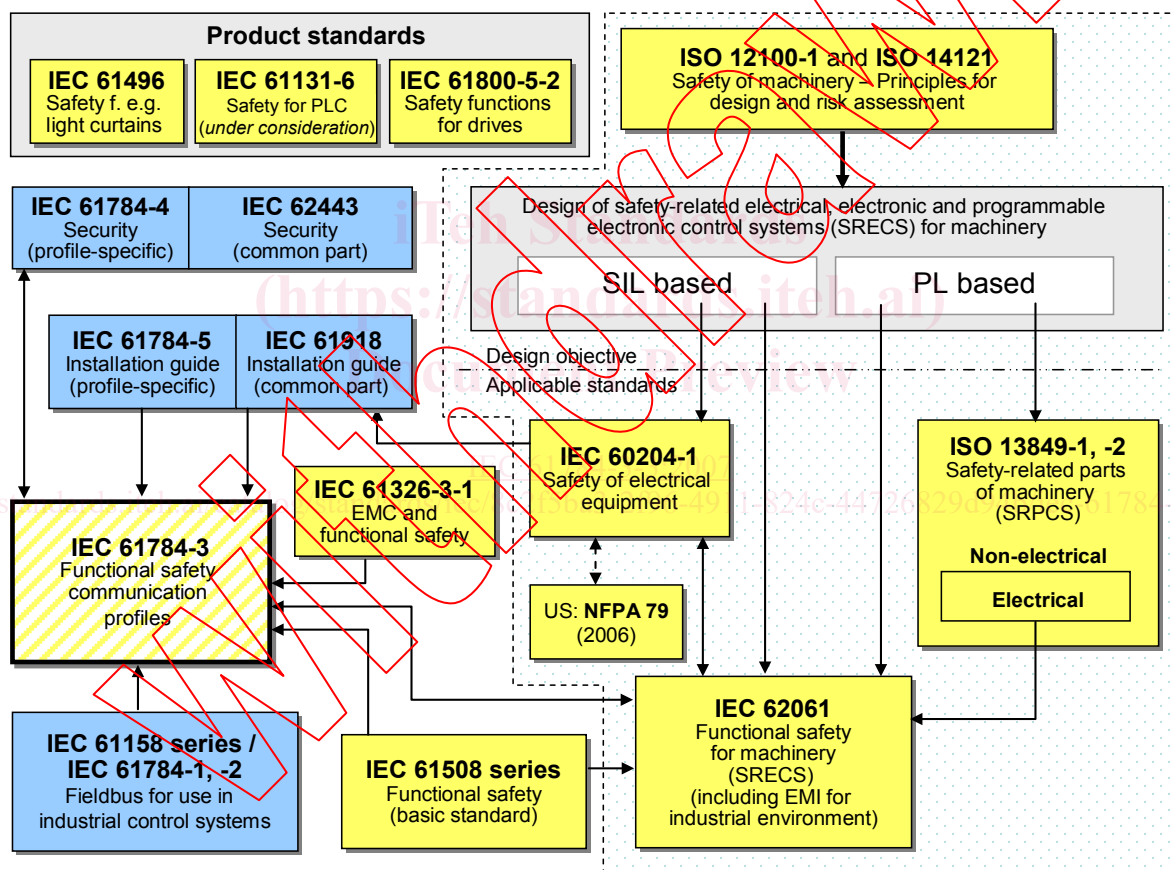
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INTRODUCTION

The IEC 61158 fieldbus standard together with its companion standards IEC 61784-1 and IEC 61784-2 defines a set of communication protocols that enable distributed control of automation applications. Fieldbus technology is now considered well accepted and well proven. Thus many fieldbus enhancements are emerging, addressing not yet standardized areas such as real time, safety-related and security-related applications.

This standard explains the relevant principles for functional safety communications with reference to IEC 61508 series and specifies several safety communication layers (profiles and corresponding protocols) based on the communication profiles and protocol layers of IEC 61784-1, IEC 61784-2 and the IEC 61158 series. It does not cover electrical safety and intrinsic safety aspects.

Figure 1 shows the relationships between this standard and relevant safety and fieldbus standards in a machinery environment.



Key

- (yellow) safety-related standards
- (blue) fieldbus-related standards
- (dashed yellow) this standard

Figure 1 – Relationships of IEC 61784-3 with other standards (machinery)

This standard describes

- basic principles for implementing the requirements of IEC 61508 series for safety-related data communications, including possible transmission faults, remedial measures and considerations affecting data integrity;
- individual description of functional safety profiles for several communication profile families in IEC 61784-1 and IEC 61784-2;
- safety layer extensions to the communication service and protocols sections of the IEC 61158 series.

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